

Features

- Planar Die Construction
- 500mW Power Dissipation on Ceramic PCB
- General Purpose, Medium Current
- Ideally Suited for Automated Assembly Processes
- Available in Lead Free Version



SOD-123



Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
MMSZ5226BT1G	SOD-123	HXY MOSFET	3000

Absolute Maximum Ratings(Ta=25°C)

Characteristic	Symbol	Value	Unit
Forward voltage @I _F =10mA	V _F	0.85	V
Power Dissipation	P_D	500	mW
Thermal Resistance, Junction to Ambient Air	$R_{\theta JA}$	556	°C/W
Junction Temperature	Ti	150	°C
Storage Temperature Range	T _{stg}	-55 ~ +150	ů

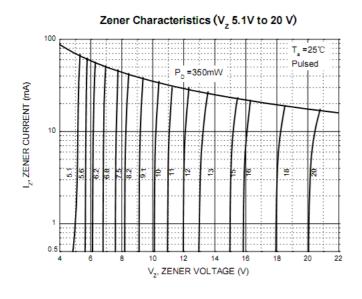
Notes: Device mounted on ceramic PCB;5.0mm×7.0mm with pad areas 35 mm²

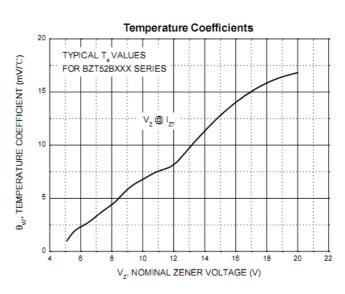
Electrical Characteristics (Ta=25°C unless otherwise specified)

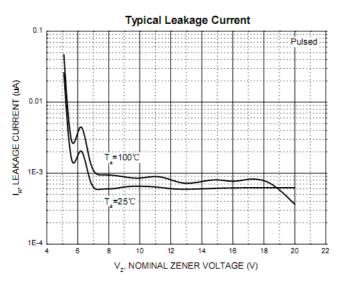
l lyno l i i	Type Code					Maximum Zener Impedance (Note 3)		Maximum Reverse Current (Note 2)		Typical Temperature Coefficient		Test Current	
			z@lzt	(V)	I _{ZT}	Vz@IzT	Vz@Izĸ	I _{ZK}	I_R	V_{R}	@I _{ZTC} mV/°C		0
		Nom	Min	Max	(mA)	2	Ω	(mA)	μΑ	٧	Min	Max	mA
MMSZ5268BT1G	G1	3.3	3.23	3.37	5	95	600	1.0	5	1.0	-3.5	0	5

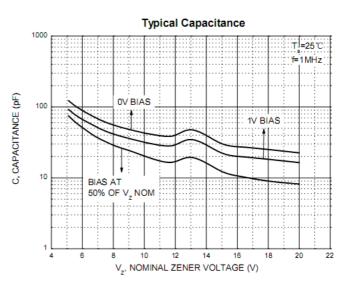


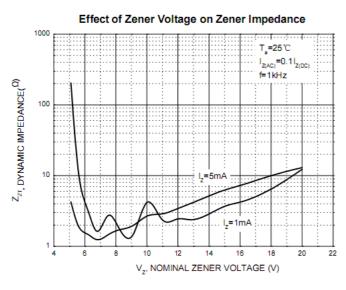
Typical Characteristics

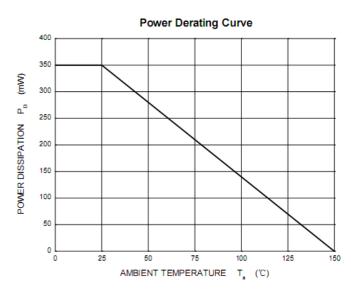






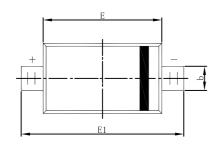


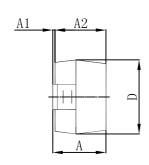


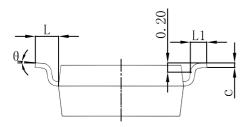




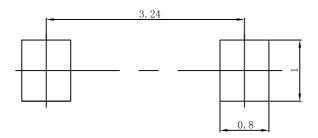
SOD-123 Package Outline Dimensions





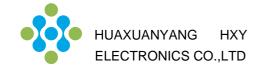


Symbol	Dimensions	In Millimeters	Dimensions In Inches			
	Min	Max	Min	Max		
Α	1.050	1.250	0.041	0.049		
A1	0.000	0.100	0.000	0.004		
A2	1.050	1.150	0.041	0.045		
b	0.450	0.650	0.018	0.026		
С	0.080	0.150	0.003	0.006		
D	1.500	1.700	0.059	0.067		
Е	2.600	2.800	0.102	0.110		
E1	3.550	3.850	0.140	0.152		
L	0.500	REF	0.020 REF			
L1	0.250	0.450	0.010	0.018		
θ	0°	8°	0°	8°		



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.



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